

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- ◆ 60V, 5A, $R_{DS(ON).max}=34m\Omega@V_{GS}=10V$
- ◆ Improved dv/dt capability
- ◆ Fast switching
- ◆ Green device available

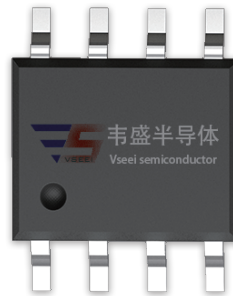
Applications

- ◆ Motor Drives
- ◆ UPS
- ◆ DC-DC Converter

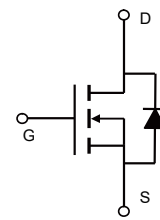
Product Summary

V_{DSS}	60V
$R_{DS(on).max}@V_{GS}=10V$	34m Ω
I_D	5A

SOP-8 Pin Configuration



SOP-8



Schematic

Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	60	V
Continuous drain current ($T_A = 25^{\circ}C$)	I_D	5	A
Continuous drain current ($T_A = 100^{\circ}C$)		3.5	A
Pulsed drain current ¹⁾	I_{DM}	20	A
Gate-Source voltage	V_{GSS}	± 20	V
Power Dissipation ($T_A = 25^{\circ}C$)	P_D	2	W
Storage Temperature Range	T_{STG}	-55 to +150	$^{\circ}C$
Operating Junction Temperature Range	T_J	-55 to +150	$^{\circ}C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^{\circ}C/W$

Package Marking and Ordering Information

Device	Device Package	Marking
VSM5N06-S8	SOP-8	VSM5N06-S8

Electrical Characteristics

 $T_J = 25^{\circ}\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static characteristics						
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	60	---	---	V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	0.9	1.4	1.9	V
Drain-source leakage current	I _{DSS}	V _{DS} =60 V, V _{GS} =0 V, T _J = 25°C	---	---	1	μA
		V _{DS} =48 V, V _{GS} =0 V, T _J = 125°C	---	---	10	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0V	---	---	100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0V	---	---	-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =5A	---	27	34	mΩ
		V _{GS} =4.5 V, I _D =4A	---	31	42	mΩ
Forward transconductance	g _{fs}	V _{DS} =5 V , I _D =5A	---	11	---	S
Dynamic characteristics						
Input capacitance	C _{iss}	V _{DS} = 30 V, V _{GS} = 0 V, F = 1MHz	---	858	---	pF
Output capacitance	C _{oss}		---	63.4	---	
Reverse transfer capacitance	C _{rss}		---	50.8	---	
Turn-on delay time	t _{d(on)}	V _{DD} = 30V,V _{GS} =10V, I _D =5A	---	14.2	---	ns
Rise time	t _r		---	85.6	---	
Turn-off delay time	t _{d(off)}		---	56.6	---	
Fall time	t _f		---	18.5	---	
Gate charge characteristics						
Gate to source charge	Q _{gs}	V _{DS} =30V, I _D =10A, V _{GS} = 10 V	---	3.7	---	nC
Gate to drain charge	Q _{gd}		---	3.6	---	
Gate charge total	Q _g		---	20.4	---	
Drain-Source diode characteristics and Maximum Ratings						
Continuous Source Current	I _S		---	---	5	A
Pulsed Source Current	I _{SM}		---	---	20	A
Diode Forward Voltage ²⁾	V _{SD}	V _{GS} =0V, I _S =5A, T _J =25°C	---	---	1.2	V
Reverse Recovery Time	t _{rr}	I _S =5A,di/dt=100A/us, T _J =25°C	---	24	---	ns
Reverse Recovery Charge	Q _{rr}		---	12	---	nC

Notes:

1: Repetitive Rating: Pulse width limited by maximum junction temperature.

2: Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.

Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

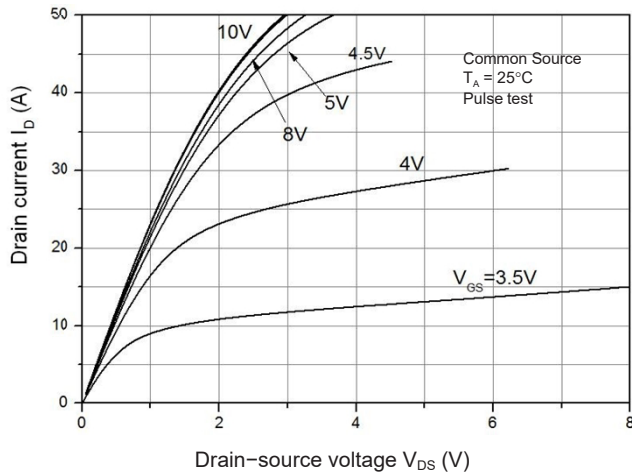


Figure 2. Transfer Characteristics

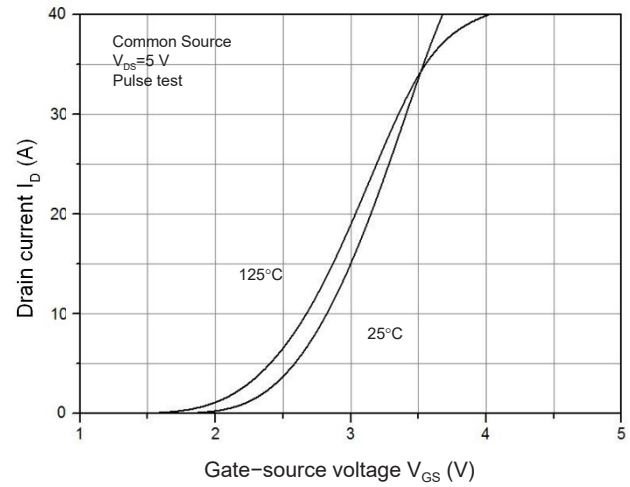


Figure 3. Capacitance Characteristics

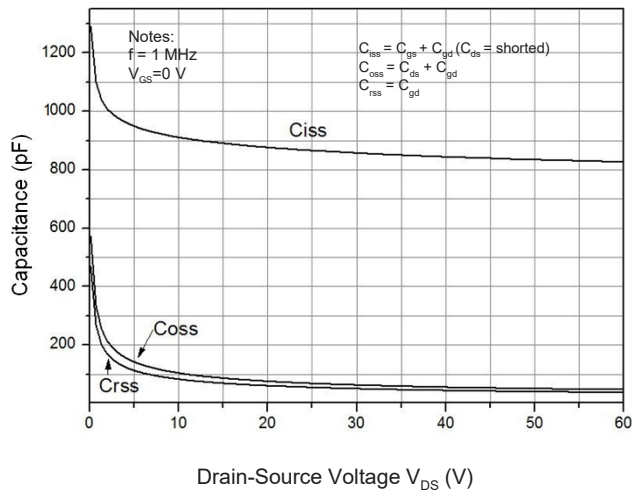


Figure 4. Gate Charge Waveform

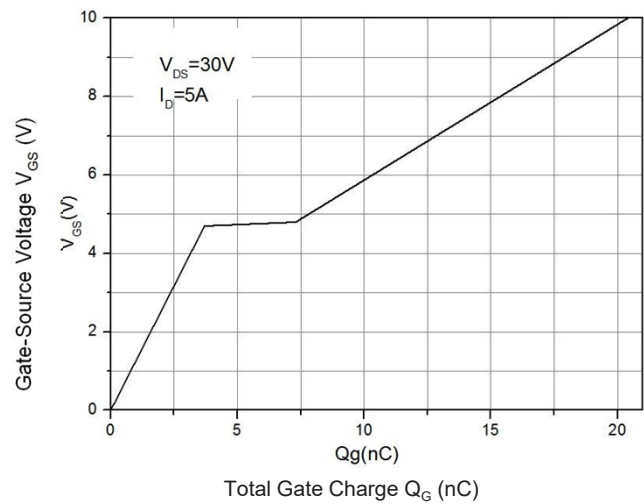


Figure 5. Body-Diode Characteristics

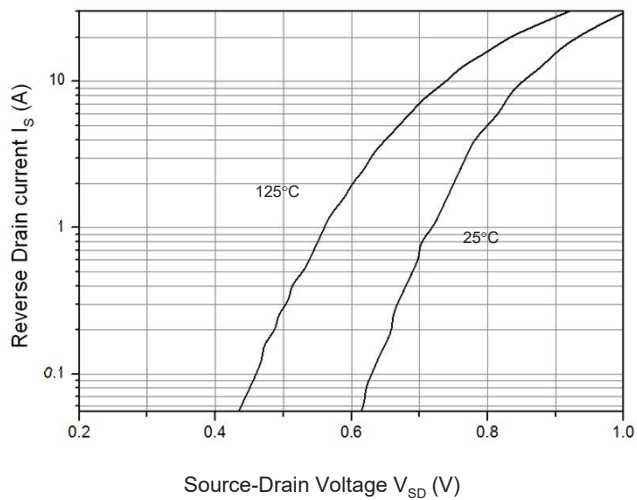


Figure 6. Rdson-Drain Current

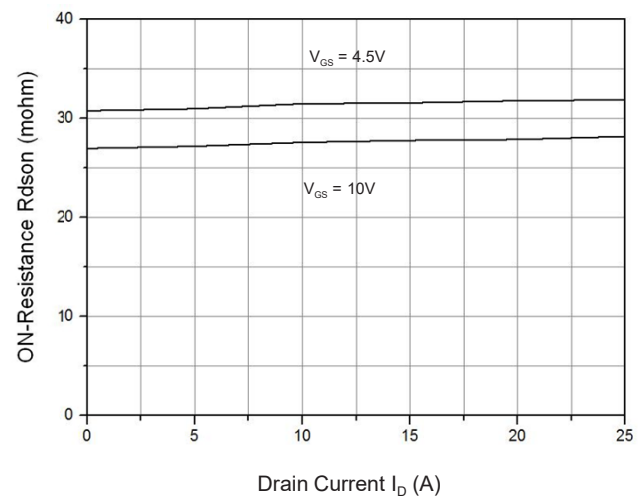


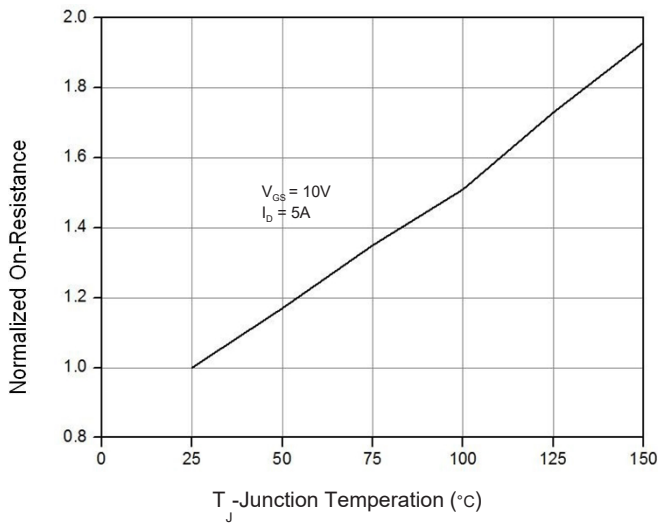
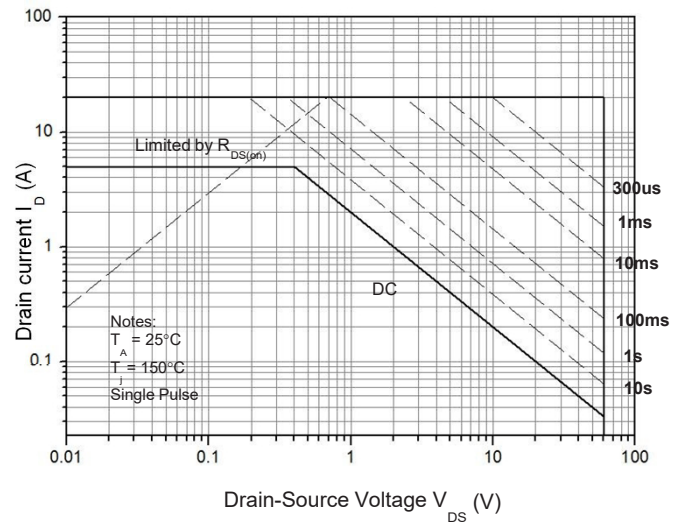
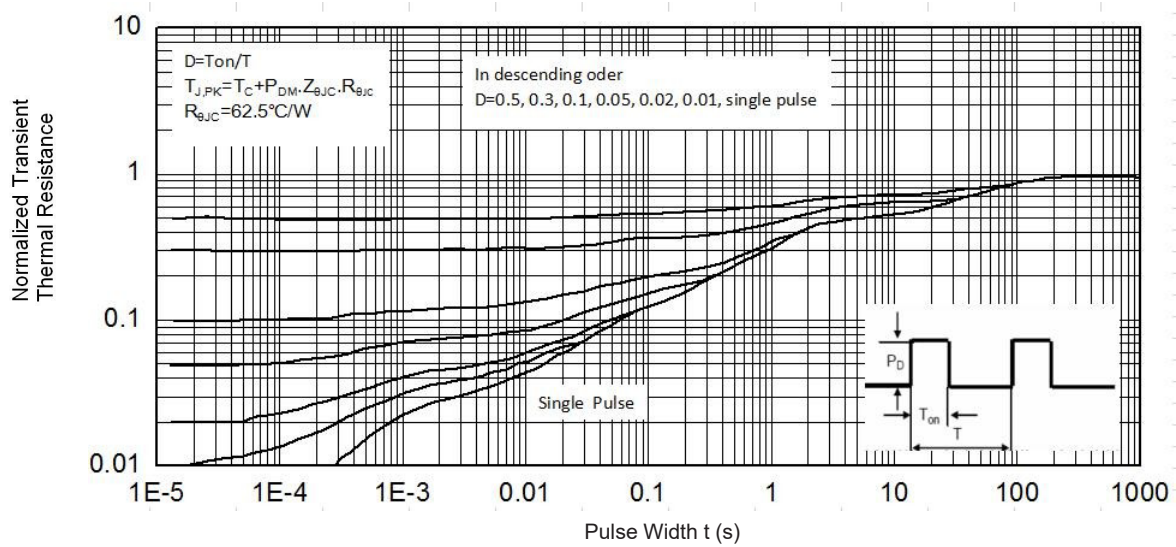
Figure 7. $R_{DS(on)}$ -Junction Temperature($^{\circ}\text{C}$)


Figure 8. Maximum Safe Operating Area


 Figure 9. Normalized Maximum Transient Thermal Impedance (R_{thJA})


Test Circuit & Waveform

Figure 10. Gate Charge Test Circuit & Waveform

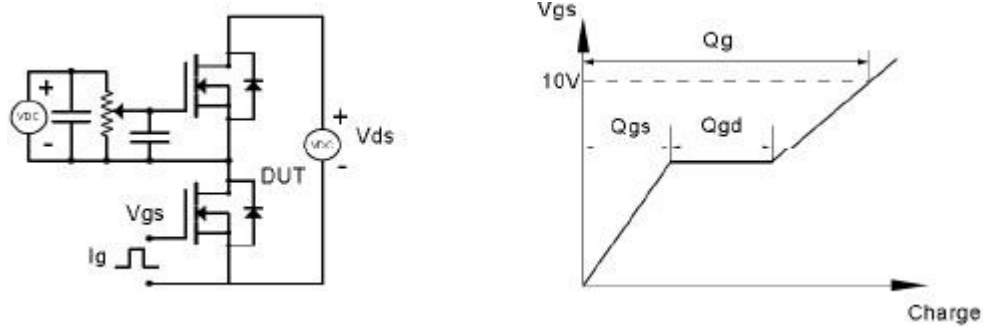


Figure 11. Resistive Switching Test Circuit & Waveforms

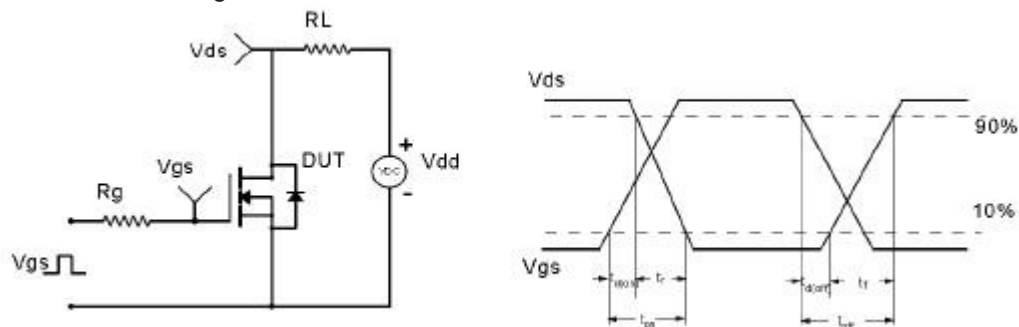


Figure 12. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

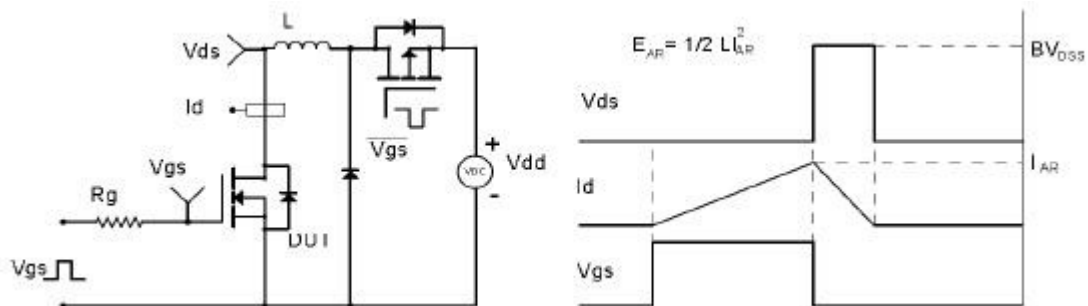


Figure 13. Diode Recovery Circuit & Waveform

